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<u>Vishay Semiconductor/Diodes Division</u> <u>VS-VSKDU162/12PBF</u>

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Distributor of Vishay Semiconductor/Diodes Division: Excellent Integrated System Limite Datasheet of VS-VSKDU162/12PBF - MOD DIODE 1200V 205A INT-A-PAK

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www.vishay.com

VS-VSKDU162/12PbF

Vishay Semiconductors

HEXFRED® Ultrafast Diodes, 100 A (New INT-A-PAK Power Modules)



New INT-A-PAK

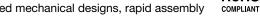
PRODUCT SUMMARY				
V_{R}	1200 V			
V _F (typical)	2.5 V			
t _{rr} (typical)	150 ns			
I _{F(DC)} at T _C	110 A at 100 °C			
Package	INT-A-PAK			
Circuit	Two diodes doubler circuit			

FEATURES

• Electrically isolated: DBC base plate



· Simplified mechanical designs, rapid assembly



- · High surge capability
- · Large creepage distances
- UL approved file E78996
- Case style New INT-A-PAK
- Designed and qualified for industrial level
- Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

ABSOLUTE MAXIMUM RATINGS					
PARAMETER	SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Cathode to anode voltage	V_R		1200	V	
Continuous forward current	I _F	T _C = 25 °C	205		
		T _C = 100 °C	110	Α	
Single pulse forward current	I _{FSM}	Limited by junction temperature	800		
Maximum nawar dinainatian	P _D	T _C = 25 °C	695	W	
Maximum power dissipation		T _C = 100 °C	280		
RMS isolation voltage	V _{ISOL}	50 Hz, circuit to base, all terminal shorted, t = 1 s	3500	V	
Operating junction and storage temperature range	T _J , T _{Stg}		-40 to + 150	°C	

ELECTRICAL SPECIFICATIONS PER LEG (T _J = 25 °C unless otherwise specified)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS
Cathode to anode breakdown voltage	V_{BR}	Ι _R = 100 μΑ	1200	ı	1	
Maximum forward voltage	V	I _F = 100 A	-	2.5	3.2	V
	V_{FM}	I _F = 160 A	-	2.9	3.9	
Maximum reverse leakage current	I _{RM}	T _J = 150 °C, V _R = 1200 V	_	18	30	mA

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DYNAMIC RECOVERY CHARACTERISTICS (T _J = 25 °C unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNITS
Reverse recovery time	t _{rr}	T _J = 25 °C		-	150	200	ns
Reverse recovery current	I _{RRM}	T _J = 25 °C	I _F = 160 A dI _F /dt = 200 A/µs	-	20	22	Α
Reverse recovery charge	Q_{rr}	T _J = 25 °C	$V_{\rm R} = 200 \text{ V}$	-	2000	2400	nC
Peak rate of recovery current	dI _{(rec)M} /dt	T _J = 25 °C		-	-	300	A/μs

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Junction operating and storage temperature range		T _J , T _{Stg}		- 40 to 150	°C	
Maximum internal thermal resistance, junction to case per leg		R_{thJC}	DC operation	0.18	°C/W	
Typical thermal resistance, case to heatsink per module		R _{thCS}	Mounting surface flat, smooth and greased	0.05		
Mounting toward 10.0/	to heatsink		A mounting compound is recommended and the	4	Nm	
Mounting torque ± 10 % —	busbar		torque should be rechecked after a period of 3 hours to allow for the spread of the compound.	6		
Approximate weight				200	g	
				7.1	OZ.	
Case style				New INT	-A-PAK	

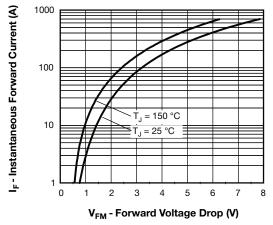


Fig. 1 - Maximum Forward Voltage Drop Characteristics

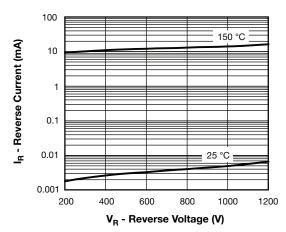


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage



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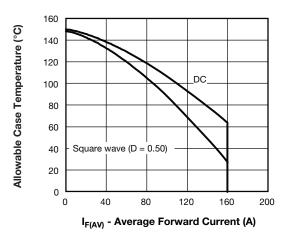


Fig. 3 - Maximum Allowable Case Temperature vs. Average Forward Current

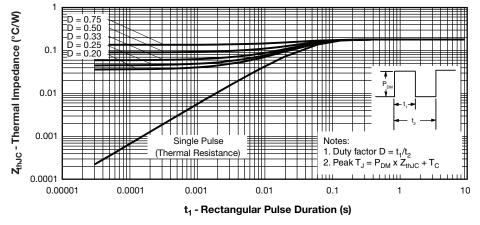


Fig. 4 - Maximum Thermal Impedance Z_{thJC} Characteristics

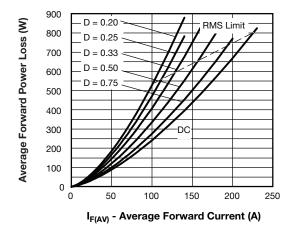


Fig. 5 - Forward Power Loss Characteristics

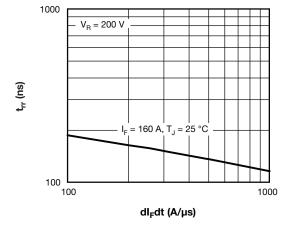


Fig. 6 - Typical Reverse Recovery Time vs. dI_F/dt (Per Leg)

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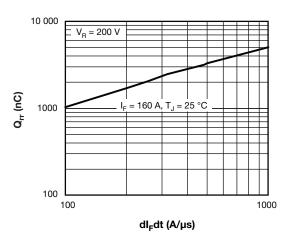


Fig. 7 - Typical Reverse Recovery Charge vs. dl_F/dt (Per Leg)

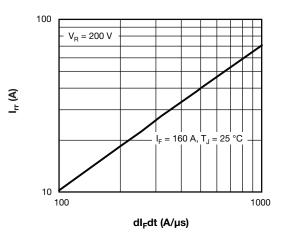
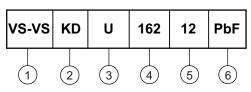


Fig. 8 - Typical Reverse Recovery Current vs. dl_F/dt (Per Leq)

ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Circuit configuration

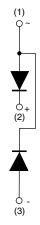
U = HEXFRED® ultrafast diode

Current rating

Voltage rating (12 = 1200 V)

6 - PbF = Lead (Pb)-free

CIRCUIT CONFIGURATION



LINKS TO RELATED DOCUMENTS				
Dimensions	www.vishay.com/doc?95254			

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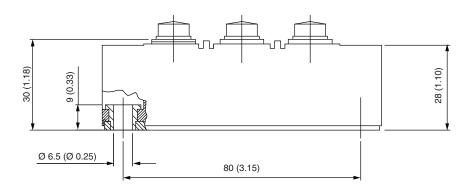


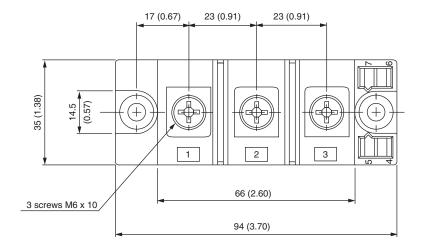
Outline Dimensions

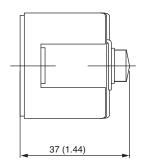
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INT-A-PAK DBC

DIMENSIONS in millimeters (inches)







Document Number: 95254 Revision: 11-Dec-07 For technical questions, contact: indmodules@vishay.com



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